



# GSX25N70E

## MOSFET

Metal Oxide Semiconductor Field Effect Transistor

Super Junction MOSFET

700V Super Junction Power Transistor

GSX25N70E

Data Sheet

Ver 1.2

2022-3-20

# 700V 25A Power MOSFET

## ■ Description

Group Semiconductor(GS) has series Multi-EPI Super-Junction power MOSFET platforms for voltage up 500V to 1000 volts, both with design service and manufacturing capability, including cell, termination design and simulation.

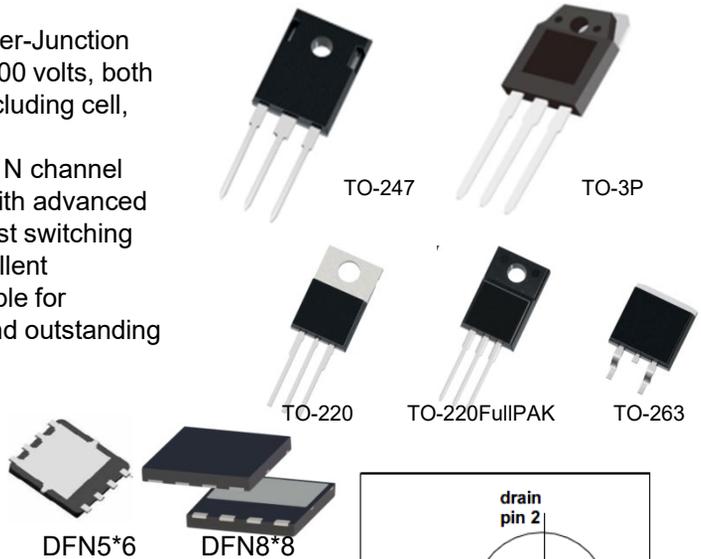
The GS 700V 25A power MOSFET is a Low voltage N channel Multi-EPI Super-Junction power MOSFET sample with advanced technology to have better characteristics, such as fast switching time, low Ciss and Crss, low on resistance and excellent avalanche characteristics, making it especially suitable for applications which require superior power density and outstanding efficiency.

## ■ Features

RDS(ON)=0.14Ω @VGS = 10V  
VDS = 700V  
ID (@ VGS=10V) = 12A

## ■ PKG

<b>GSA25N70E</b>	<b>GSP25N70E</b>	<b>GSB25N70E</b>		
TO-220Fullpak	TO-220	TO-263		
GSW25N70E	GSJ25N70E	GSN25N70E	GSM25N70E	
TO-247	TO-3P	DFN5*6	DFN8*8	



## ■ Absolute Maximum Ratings (TC = 25° C, unless otherwise specified)

Symbol	Parameter	GSP25N70E	GSA25N70E	Unit
V <sub>DSS</sub>	Drain-Source Voltage	700		V
I <sub>D</sub>	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)	25* 15*		A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	53		A
V <sub>GSS</sub>	Gate-Source voltage	±30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	500		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	4		A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	1.2		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	15		V/ns
dVds/dt	Drain Source voltage slope (Vds=480V)	50		V/ns
P <sub>D</sub>	Power Dissipation (TC = 25°C)	151	35	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C
T <sub>L</sub>	Max. Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300		°C

# 700V 25A Power Transistor

## ■ Electrical Characteristics (T<sub>J</sub>=25° C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 25°C	700	--	--	V
		V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 150°C	--	750	--	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	--	0.6	--	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 700V, V <sub>GS</sub> = 0V -T <sub>J</sub> =25 °C -T <sub>J</sub> = 150°C	--	-- 10	1 -	μA μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V	--	--	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2	--	4	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12A	--	0.12	0.14	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40V, I <sub>D</sub> = 12A	--	16	--	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz	--	1650	-	pF
C <sub>oss</sub>	Output Capacitance		--	90	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	9	--	pF
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 560V (Note 4)	--	28	--	ns
t <sub>r</sub>	Turn-On Rise Time		--	19	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	140	--	ns
t <sub>f</sub>	Turn-Off Fall Time		--	12	--	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 560V, I <sub>D</sub> = 12A V <sub>GS</sub> = 10V (Note 4)	--	110	140	nC
Q <sub>gs</sub>	Gate-Source Charge		--	9	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	15	--	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		--	--	25	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		--	--	75	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12A	--	0.9	1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12A dI <sub>F</sub> /dt = 100A/μs	--	500	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	6	--	μC

### NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L=60mH, I<sub>AS</sub>=3A, V<sub>DD</sub>=150V, Starting T<sub>J</sub>=25 °C
3. I<sub>SD</sub>≤4.5A, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25 °C
4. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
5. Essentially Independent of Operating Temperature Typical Characteristics

# 700V 25A Power Transistor

## ■ Thermal Characteristics

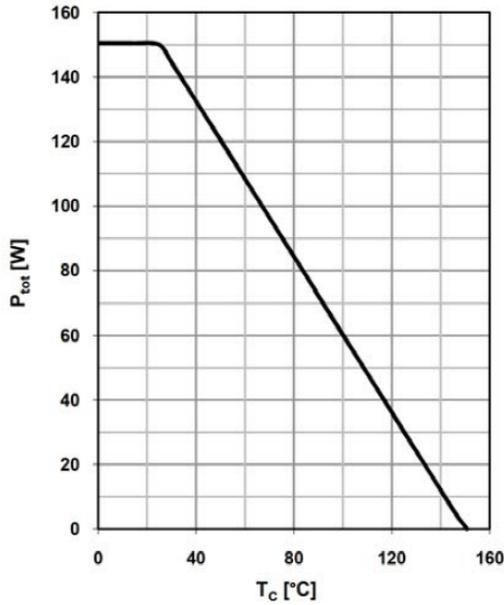
Symbol	Parameter	GSA25N70E	GSP25N70E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.2	1.2	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62	62	°C/W

Symbol	Parameter	Value (TO220)	Unit
$R_{\theta JA}^{(6)}$	Maximum Junction-to-Ambient	82	°C/W
$R_{\theta CS}^{(6)}$	Maximum Case-to-sink	0.6	°C/W
$R_{\theta JC}^{(7),(8)}$	Maximum Junction-to-Case $\theta$	4.1	°C/W

1. The power dissipation PD is based on  $T_J(\text{MAX})=150^\circ \text{C}$  in a TO251 package, using junction-to-case thermal resistance.
2. Repetitive rating, pulse width limited by junction temperature  $T_J(\text{MAX})=150^\circ \text{C}$ .
3.  $L=1\text{mH}$ , Starting  $T_J=25^\circ \text{C}$ .
4.  $L=10\text{mH}$ , starting  $T_J=25^\circ \text{C}$ .
5.  $L=60\text{mH}$ , starting  $T_J=25^\circ \text{C}$ .
6. The tests are performed with the device with  $T_A=25^\circ \text{C}$ .
7. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.
8. These curves are based on the junction-to-case thermal impedance, assuming a maximum junction temperature of  $T_J(\text{MAX})=150^\circ \text{C}$ .

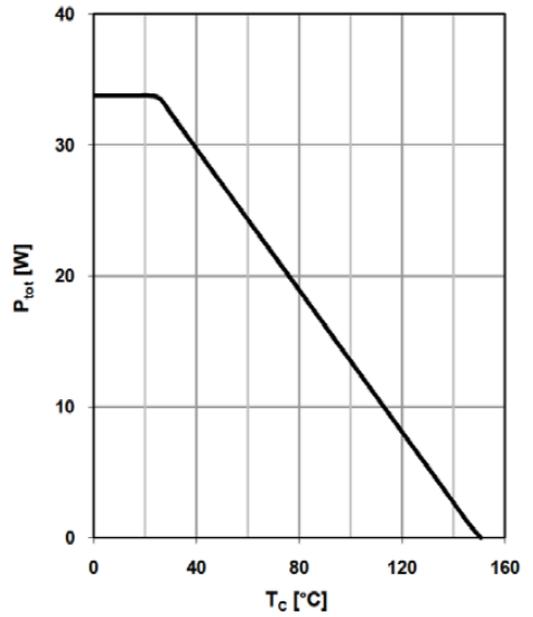
## Typical Performance Characteristics

**Power dissipation  
Non FullPAK**



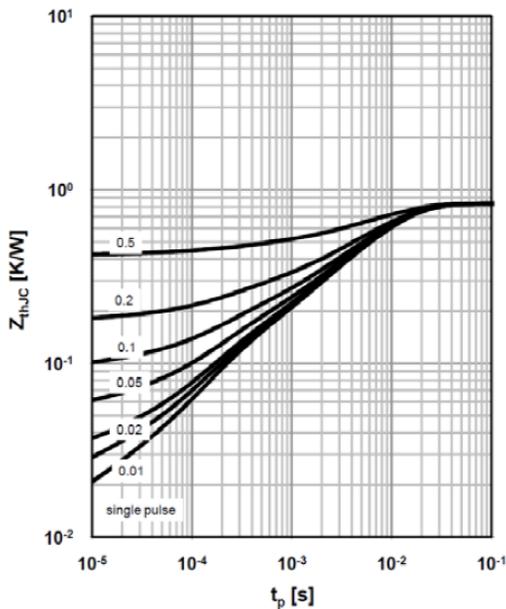
$$P_{tot} = f(T_c)$$

**Power dissipation  
FullPAK**



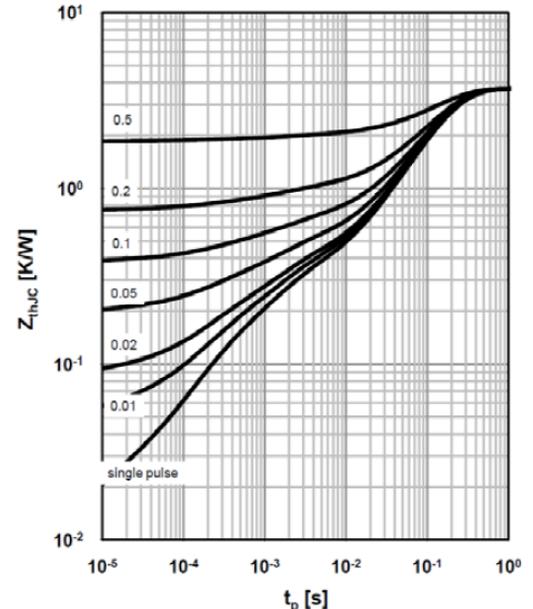
$$P_{tot} = f(T_c)$$

**Max. transient thermal impedance  
Non FullPAK**



$$Z_{(thJC)} = f(t_p); \text{ parameter: } D = t_p/T$$

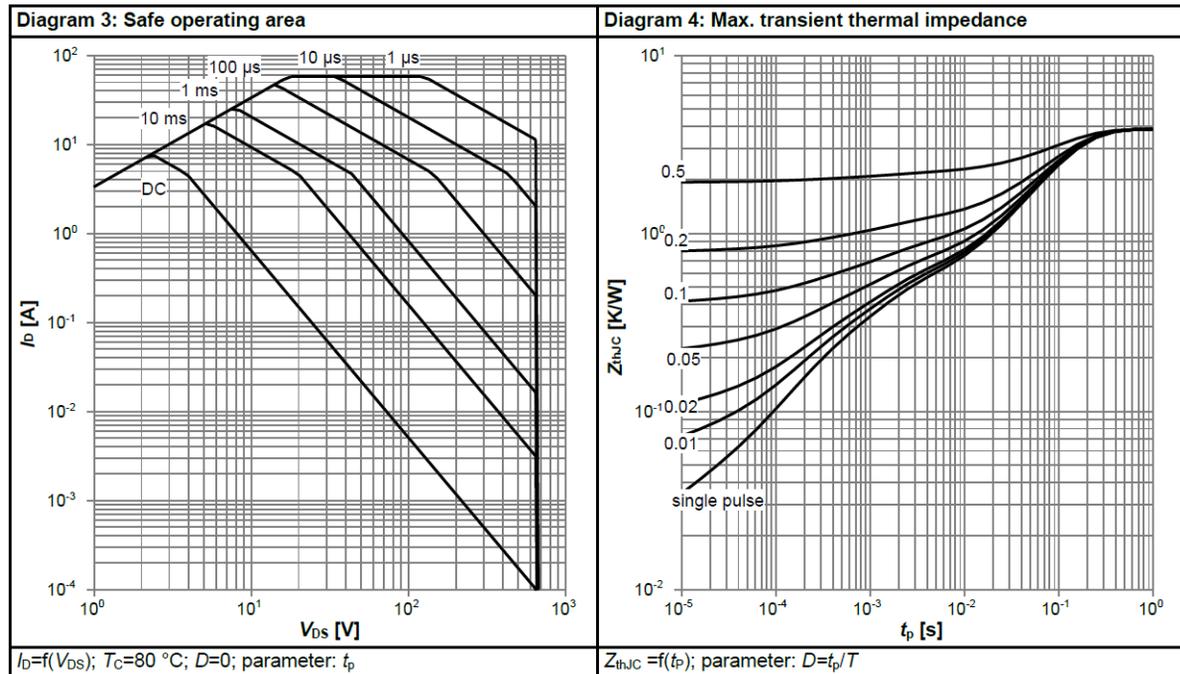
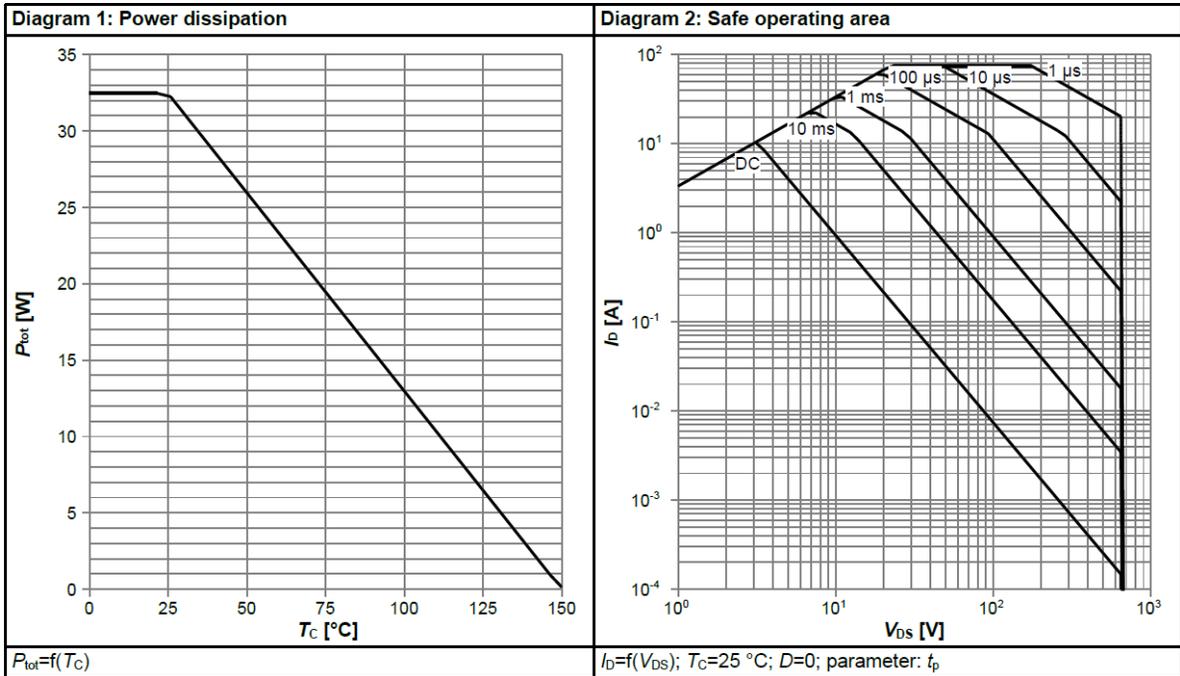
**Max. transient thermal impedance  
FullPAK**



$$Z_{(thJC)} = f(t_p); \text{ parameter: } D = t_p/T$$

# 700V 25A Power Transistor

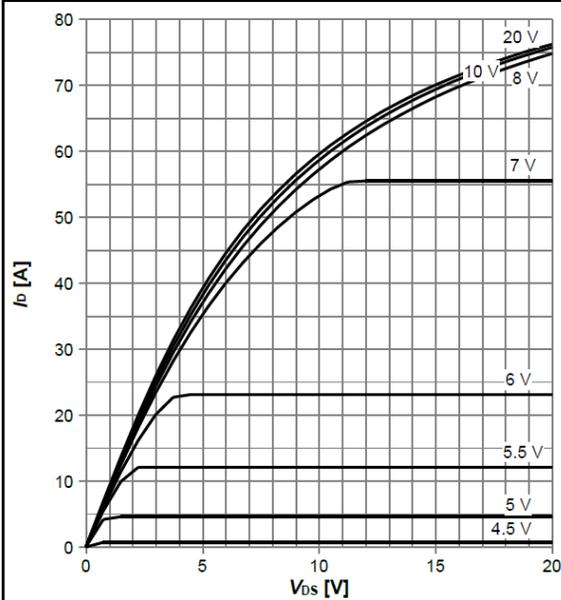
## Typical Performance Characteristics



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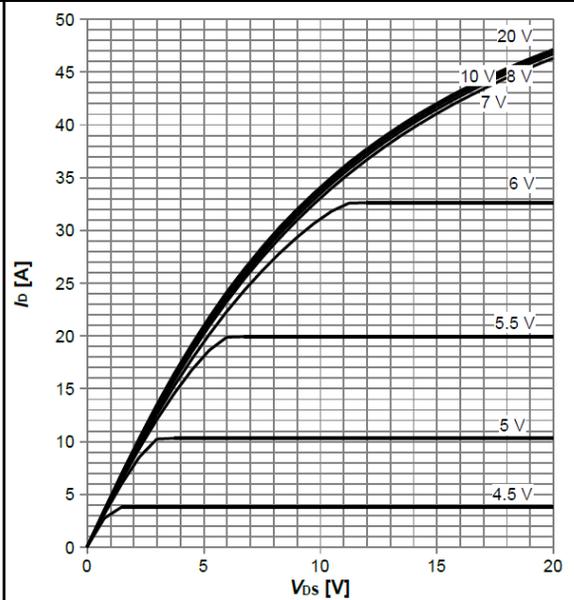
## Typical Performance Characteristics

Diagram 5: Typ. output characteristics



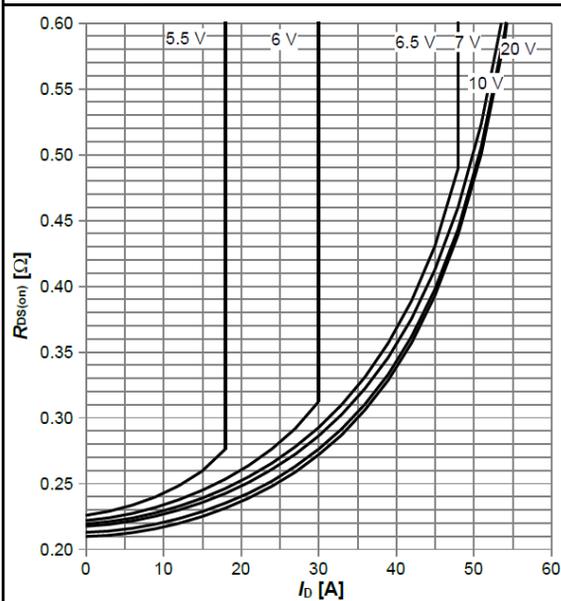
$I_D = f(V_{DS})$ ;  $T_j = 25\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. output characteristics



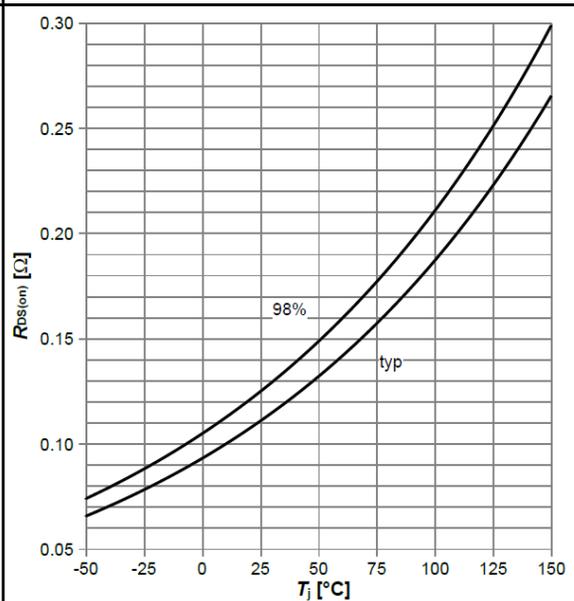
$I_D = f(V_{DS})$ ;  $T_j = 125\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. drain-source on-state resistance



$R_{DS(on)} = f(I_D)$ ;  $T_j = 125\text{ °C}$ ; parameter:  $V_{GS}$

Diagram 8: Drain-source on-state resistance

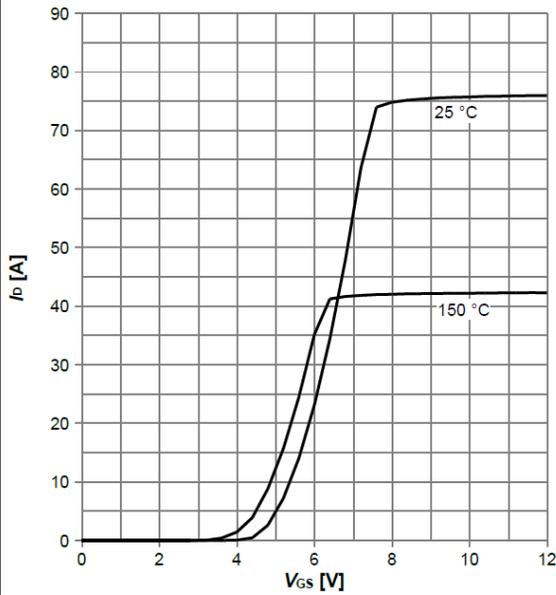


$R_{DS(on)} = f(T_j)$ ;  $I_D = 8.9\text{ A}$ ;  $V_{GS} = 10\text{ V}$

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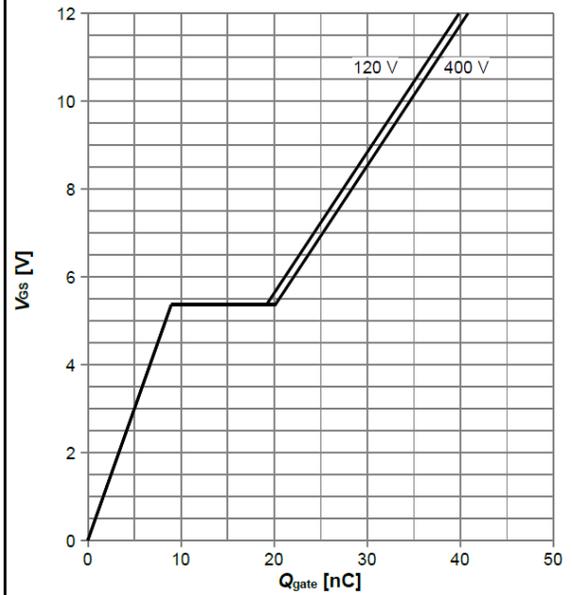
## Typical Performance Characteristics

Diagram 9: Typ. transfer characteristics



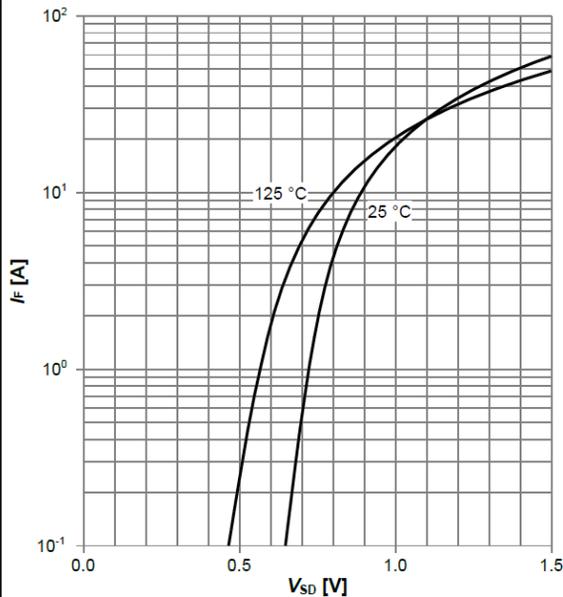
$I_D = f(V_{GS})$ ;  $V_{DS} = 20V$ ; parameter:  $T_j$

Diagram 10: Typ. gate charge



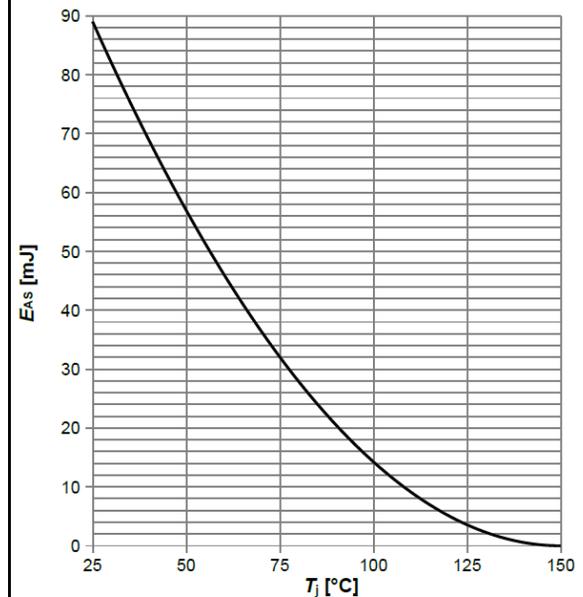
$V_{GS} = f(Q_{gate})$ ;  $I_D = 8.9A$  pulsed; parameter:  $V_{DD}$

Diagram 11: Forward characteristics of reverse diode



$I_F = f(V_{SD})$ ; parameter:  $T_j$

Diagram 12: Avalanche energy

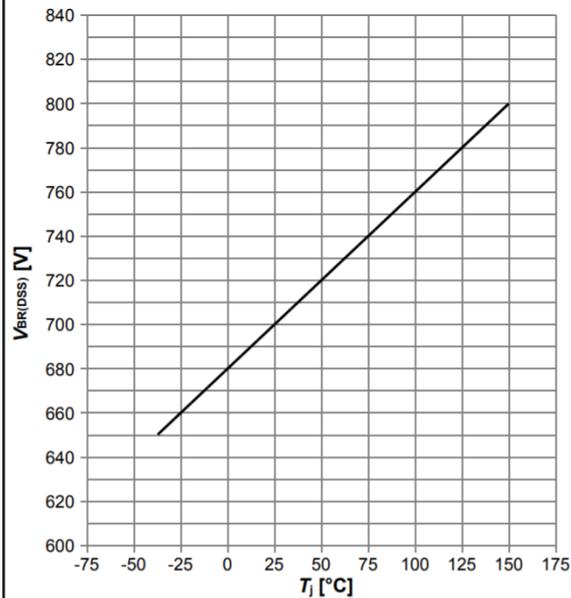


$E_{AS} = f(T_j)$ ;  $I_D = 7.1 A$ ;  $V_{DD} = 50 V$

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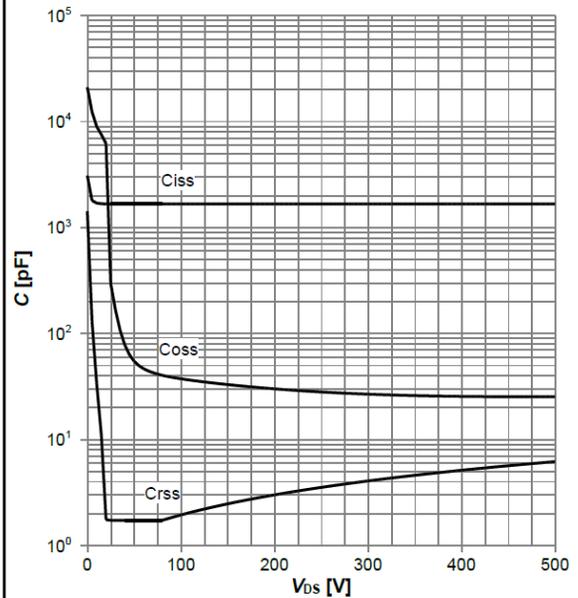
## Typical Performance Characteristics

Diagram 13: Drain-source breakdown voltage



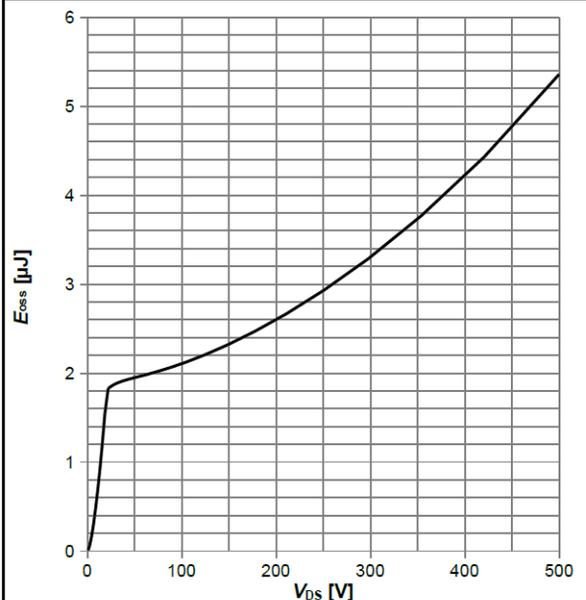
$V_{BR(DSS)}=f(T_j); I_D=1 \text{ mA}$

Diagram 14: Typ. capacitances



$C=f(V_{DS}); V_{GS}=0 \text{ V}; f=250 \text{ kHz}$

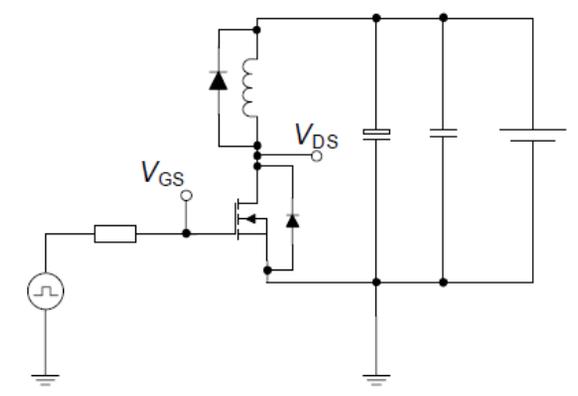
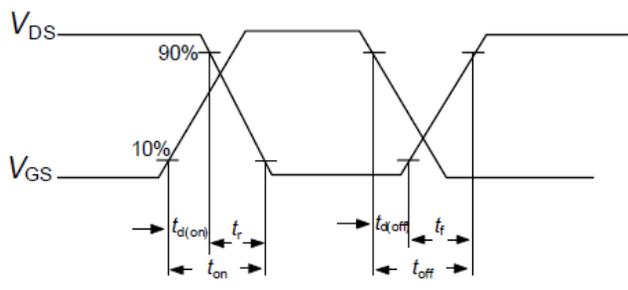
Diagram 15: Typ. Coss stored energy



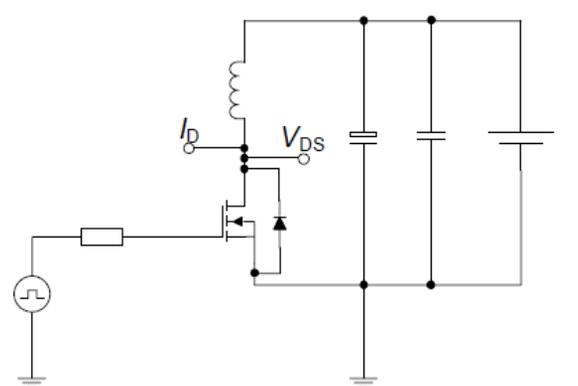
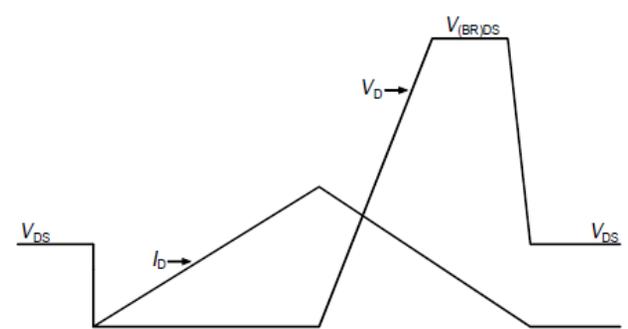
$E_{Coss}=f(V_{DS})$

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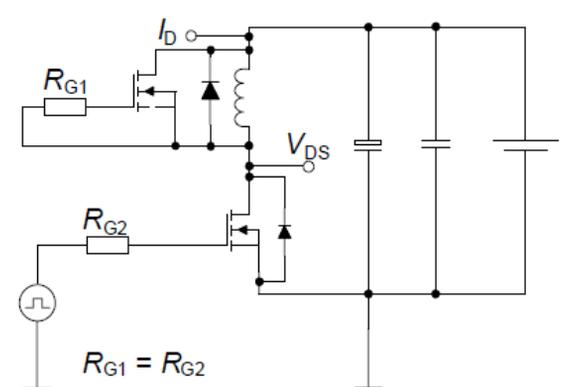
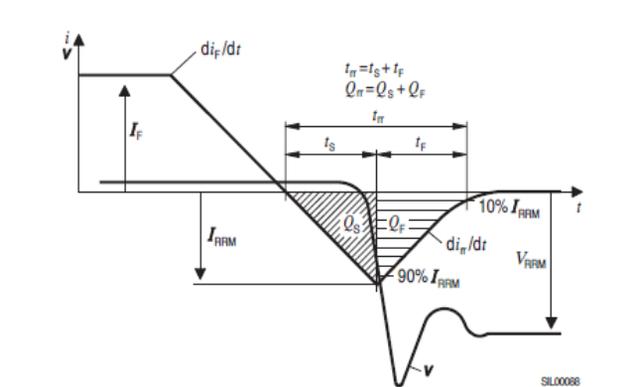
**Table 20** Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load	Switching time waveform
	

**Table 21** Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit	Unclamped inductive waveform
	

**Table 22** Test circuit and waveform for diode characteristics

Test circuit for diode characteristics	Diode recovery waveform
 <p><math>R_{G1} = R_{G2}</math></p>	 <p><math>t_{rr} = t_s + t_f</math>  <math>Q_{rr} = Q_S + Q_F</math></p>